

# MIC79110

## Simple 1.2A Linear Li-ion Battery Charger

#### Features

- Input Voltage Range: 2.5V to 16V
- High Output Voltage Accuracy of ±0.75% over -5°C to +60°C
- Current Limit ±5% Accurate from  $-5^{\circ}C \le T_{J} \le +125^{\circ}C$
- Programmable End-of-Charge Flag
- Analog Output Proportional to Output Current
- Adjustable and Fixed 4.2V Output
- Low Dropout Voltage of 550 mV at 700 mA Load, over Temperature
- 1.2A Maximum Charge Current
- · Excellent Line and Load Regulation Specifications
- Reverse-Current Protection
- Thermal Shutdown and Current-Limit Protection
- Tiny 10-Lead 3 mm x 3 mm VDFN Package
- Junction Temperature Range: –40°C to +125°C

#### Applications

- Cellular Phones and PDAs
- Digital Cameras and Camcorders
- MP3 Players
- Notebook PCs
- Portable Meters

**Package Types** 

Cradle/Car Chargers and Battery Packs

#### **General Description**

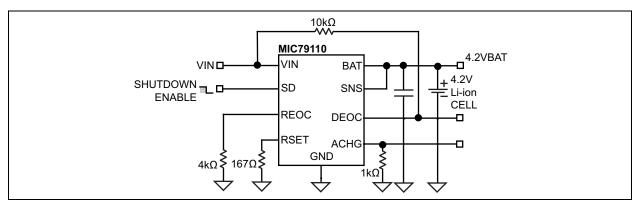
The MIC79110 is a simple and accurate lithium-ion battery charger. The part features a built-in pass transistor, precision programmable current limiting ( $\pm$ 5%), and precision voltage termination ( $\pm$ 0.75% over temperature). The MIC79110 packs full functionality into a small space.

Other features of the MIC79110 include two independent indicators: a digital end-of-charge signal that is programmable with a resistor-to-ground and an analog current output that is proportional to the output current, allowing for monitoring of the actual charging current. Additional features include very low dropout (550 mV over the temperature range), thermal shutdown, and reverse polarity protection. In the event the input voltage to the charger is disconnected, the MIC79110 also provides minimal reverse-current and reversed-battery protection.

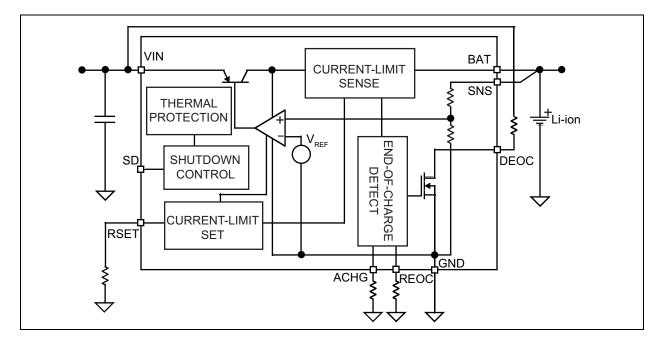
Available in both fixed 4.2V and adjustable outputs, the MIC79110 is offered in the leadless 10-pin 3 mm x 3 mm VDFN with an operating junction temperature range of  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

#### **MIC79110 MIC79110** 10-Lead VDFN (ML) 10-Lead VDFN (ML) (Top View, Fixed Version) (Top View, Adjustable Version) GND GND 10 10 SD SD 9 REOC 2 REOC RSET 2 RSET i 9 DEOC SNS 3 8 DEOC 3 i 8 ADJ 4 7 ACHG BAT ACHG BAT VIN 5 VIN 5 6 6 VIN VIN

#### **Typical Application Circuit**



#### **Functional Block Diagram**



### 1.0 ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings †

Input Supply Voltage (V <sub>IN</sub> )	
Shutdown Input Voltage (V <sub>SD</sub> )	
Output Voltage (ADJ)	
Power Dissipation	

#### **Operating Ratings ‡**

Input Supply Voltage	
Shutdown Input Voltage (V <sub>SD</sub> )	
Output Voltage (ADJ)	

**†** Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

**‡ Notice:** The device is not guaranteed to function outside its operating ratings.

#### **ELECTRICAL CHARACTERISTICS**

**Electrical Characteristics:**  $T_A = +25^{\circ}C$  with  $V_{IN} = V_{OUT} + 1V$ ;  $I_{LOAD} = 100 \ \mu$ A;  $C_{BAT} = 10 \ \mu$ F; SD = 0V;  $R_{SET} = 1 \ k\Omega$ . **Bold** values valid for  $-40^{\circ}C < T_J < +125^{\circ}C$ ; unless otherwise specified. Note 1

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Output Voltage Assurage	N	-0.75	_	0.75	%	V <sub>OUT</sub> = 4.2V; I <sub>LOAD</sub> = 50 mA; T <sub>J</sub> = –5°C to +60°C
Output Voltage Accuracy	Vo	-1.5	_	1.5	70	V <sub>OUT</sub> = 4.2V; I <sub>LOAD</sub> = 50 mA; T <sub>J</sub> = –40°C to +125°C
ADJ Pin Voltage Accuracy	—	0.5955	0.6	0.6045	V	—
Line Regulation	ΔV <sub>OUT</sub> / (V <sub>OUT</sub> x ΔV <sub>IN</sub> )	-0.1	_	0.1	%/V	V <sub>IN</sub> = V <sub>OUT</sub> + 1V to 16V @ I <sub>LOAD</sub> = 50 mA
Load Regulation	ΔV <sub>OUT</sub> / V <sub>OUT</sub>	—	0.3	_	%	$I_{LOAD} = 0.1 \text{ mA to } 1\text{A}$
Propout Voltago, Noto 2	V.	—	160	250	mV	I <sub>LOAD</sub> = 100 mA, R <sub>SET</sub> = 167Ω
Dropout Voltage, Note 2	V <sub>DO</sub>	_	375	550	mv	I <sub>LOAD</sub> = 700 mA, R <sub>SET</sub> = 167Ω
Ground Current	I <sub>GND</sub>	—	2	3	mA	I <sub>LOAD</sub> = 10 mA, R <sub>SET</sub> = 167Ω
Ground Current		—	24	35		I <sub>LOAD</sub> = 700 mA, R <sub>SET</sub> = 167Ω
VIN Pin Current	I <sub>VIN</sub>	_	120	300	μA	SD = V <sub>IN</sub>
Shutdown Pin Current	I <sub>SD</sub>	—	0.1	5	μA	SD = 5.2V, V <sub>BAT</sub> = 0V
Shutdown Input Threshold	V <sub>SD_TH</sub>	1.05	_	_	V	Logic High, regulator off
Shutdown input Threshold		_	_	0.93	v	Logic Low, regulator on
Shutdown Hysteresis	$V_{SD_HYS}$	—	60	_	mV	—
Current Limit Accuracy (Note 3,	_	-5	_	5	%	V <sub>OUT</sub> = 0.9 x V <sub>NOM</sub> ; I <sub>OUT</sub> = 1.2A, R <sub>SET</sub> = 167Ω, T <sub>J</sub> = -40°C to +85°C
Note 4)		-20	_	20	70	V <sub>OUT</sub> = 0.9 x V <sub>NOM</sub> ; I <sub>OUT</sub> = 0.1A, R <sub>SET</sub> = 2 kΩ
Current Limit Setpoint Range	I <sub>CHRG_RNG</sub>	0.1	_	1.2	А	Note 4
Maximum Current Limit	I <sub>LIM(MAX)</sub>	1.25	1.65	2.5	А	R <sub>SET</sub> shorted to ground, V <sub>BAT</sub> = 0.9 x V <sub>NOM</sub>
V <sub>BAT</sub> Reverse Current	I <sub>BAT_REV</sub>	—	4.2	20	μA	V <sub>IN</sub> = High impedance or ground

#### ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Characteristics:**  $T_A = +25^{\circ}C$  with  $V_{IN} = V_{OUT} + 1V$ ;  $I_{LOAD} = 100 \ \mu$ A;  $C_{BAT} = 10 \ \mu$ F; SD = 0V;  $R_{SET} = 1 \ k\Omega$ . **Bold** values valid for  $-40^{\circ}C < T_J < +125^{\circ}C$ ; unless otherwise specified. Note 1

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Digital End-of-Charge (DEOC) Output								
		35	50	65	mA			
End of Charge Current (Note 5,	1	30	50	70	IIIA	$R_{EOC} = 4 k\Omega$ , Current Falling		
Note 6)	IEOC	50	70	95	m۸	B = 4 kQ Current Biging		
		40	70	100	mA	$R_{EOC}$ = 4 k $\Omega$ , Current Rising		
Digital End of Charge Logic Low Voltage	D <sub>EOC_LOW</sub>		0.74	0.95	V	I <sub>EOC</sub> = 5 mA, I <sub>BAT</sub> = 700 mA		
Digital End of Charge Leakage Current	D <sub>EOC_LK</sub>		0.1		μA	Logic HIGH = V <sub>IN</sub> = 16V		
Digital End of Charge On Resistance	D <sub>EOC</sub> _ RDS(ON)		150	190	Ω	V <sub>IN</sub> = +5V		
R <sub>EOC</sub> Maximum Current Limit		0.5	1.0	2.0	mA	R <sub>EOC</sub> shorted to ground		
Analog Charge Indicator (ACH	Analog Charge Indicator (ACHG) Output							
Source Current, Note 7		37	46	55		I <sub>BAT</sub> = 50 mA		
	ISOURCE	800	950	1150	μA	$I_{BAT}$ = 1.2A, $T_{J}$ = -40°C to +85°C		

Note 1: Specification for packaged product only.

**2:** Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential. For outputs below 2.5V, dropout voltage is the input-to-output voltage differential with the minimum input voltage 2.5V. Minimum input operating voltage is 2.5V.

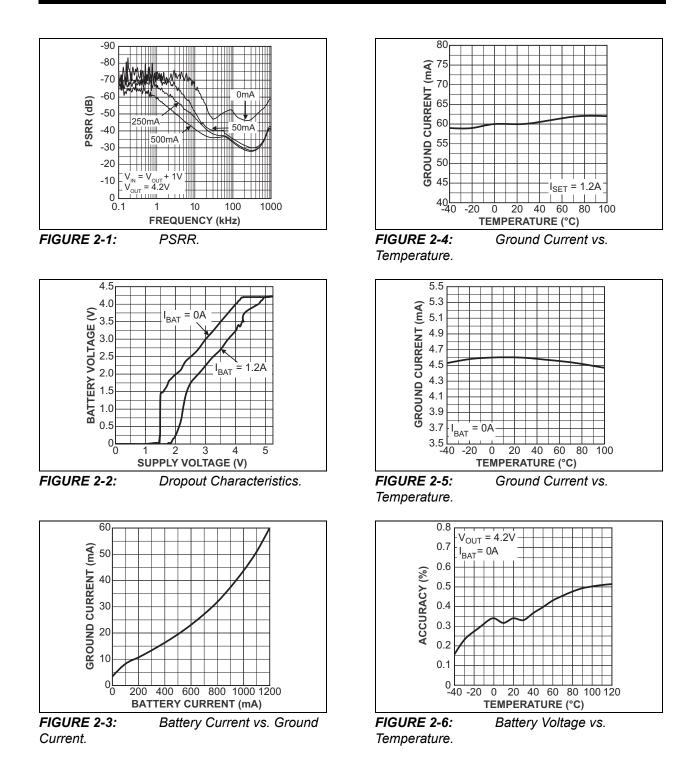
- **3:** V<sub>NOM</sub> denotes the nominal output voltage.
- **4:**  $I_{RSET} = (0.2V/R_{SET}) \times 1000.$
- **5:** Output current I<sub>EOC</sub> when digital end-of-charge output goes high impedance. Currents greater than I<sub>EOC</sub>, the DEOC output is low, currents lower than I<sub>EOC</sub>, DEOC is high impedance.
- **6:**  $I_{EOC} = (0.2V/R_{EOC}) \times 1000.$
- 7: I<sub>SOURCE</sub> is the current output from ACHG pin. A resistor to ground from the ACHG pin will program a voltage that is proportional to the output current.

#### **TEMPERATURE SPECIFICATIONS**

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Junction Temperature Range	Τ <sub>J</sub>	-40	_	+125	°C	—	
Package Thermal Resistances							
Thermal Resistance V/DEN 10 Ld	$\theta_{JA}$	_	60	_	°C/W	—	
Thermal Resistance, VDFN 10-Ld	θ <sub>JC</sub>	—	2	—	°C/W	—	

#### 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



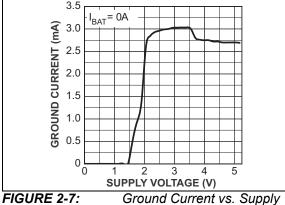
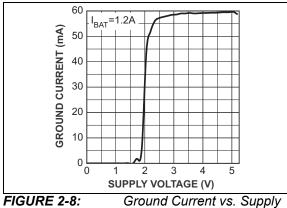
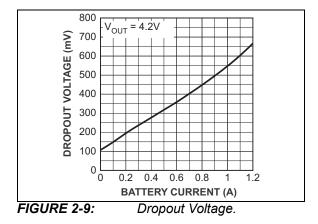


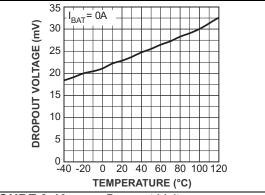
FIGURE 2-7: Ground Current vs. Supp. Voltage.



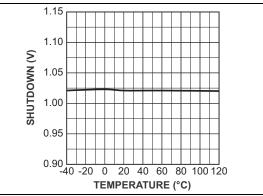
Voltage.







**FIGURE 2-10:** Dropout Voltage vs. Temperature.



**FIGURE 2-11:** Shutdown Threshold vs. Temperature.

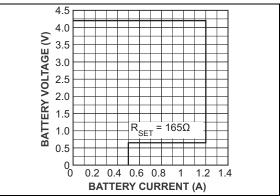
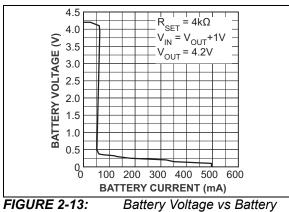
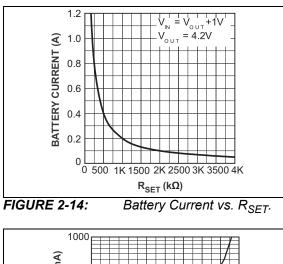
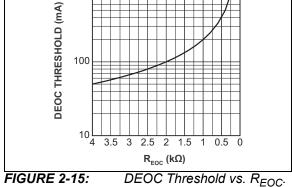


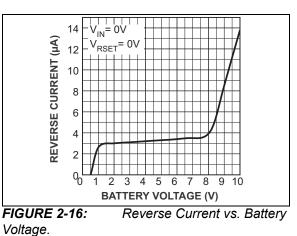
FIGURE 2-12: Battery Voltage vs. Battery Current.



Current.







50 45 40 HYSTERESIS (mV) 35 30 25 20 15 10 5 -40 -20 20 40 60 80 100 120 0 **TEMPERATURE (°C)** 

FIGURE 2-17: DEOC Hys

DEOC Hysteresis.

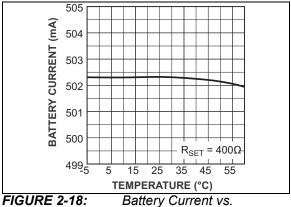


FIGURE 2-18: Battery Current vs Temperature.

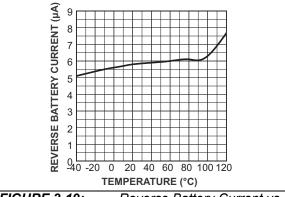
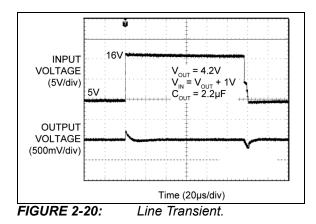


FIGURE 2-19: Reverse Battery Current vs. Temperature.



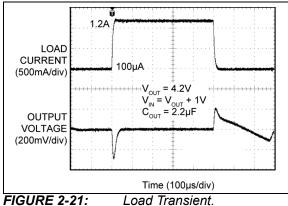
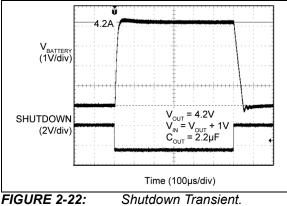
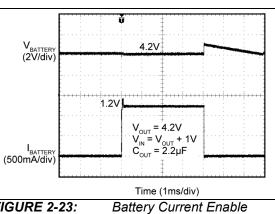


FIGURE 2-21:



**FIGURE 2-22:** 



**FIGURE 2-23:** Transient.

#### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

Pin Number	Pin Name	Description
1	SD	Shutdown Input. Logic HIGH = Off; Logic LOW = On.
2	RSET	Current limit: Sets constant current limit via an external resistor to ground. $I_{RSET} = (0.2V/R_{SET}) \times 1000.$
3	SNS	(Fixed voltage only): Sense output: connect directly to battery.
5	ADJ	(Adjustable voltage only): Feedback input.
4	BAT	Battery Terminal. Connect to single-cell lithium-ion battery.
5, 6	VIN	Input supply pins.
7	ACHG	Analog Charge Indicator Output: Current source whose output current is equal to 1/1000 of the BAT pin current.
8	DEOC	Digital End-of-Charge Output: N-Channel open-drain output. LOW indicates charging, a current that is higher than the programmed current set by $R_{EOC}$ is charging the battery. When the current drops to less than the current set by $R_{EOC}$ , the output goes high impedance, indicating end-of-charge.
9	REOC	End-of-Charge Set: Sets end-of-charge current threshold via an external resistor to ground. $I_{EOC} = (0.2V/R_{EOC}) \times 1000$ .
10	GND	Ground.

TABLE 3-1: PIN FUNCTION TABLE

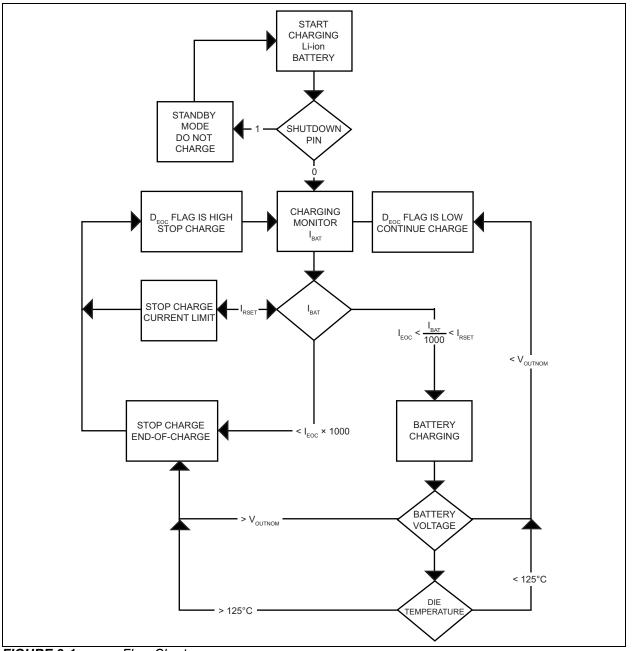


FIGURE 3-1: Flow Chart.

#### 4.0 APPLICATION INFORMATION

#### 4.1 Detailed Description

The MIC79110 forms a complete charger for 1-cell lithium-ion batteries. It includes precision voltage control (0.75% over temperature) to optimize both cell performance and cycle life. All are compatible with common 4.2V lithium-ion chemistries. Voltages other than 4.2V can be obtained with the adjustable version. Other features include current limit, end-of-charge flag, and end-of-charge current limit using an external resistor. The shutdown pin enables low quiescent current when not charging.

#### 4.2 Current Limit Mode

MIC79110 features an internal current limit that is set by the RSET pin with a resistor-to-ground. The maximum current is calculated by Equation 4-1:

#### **EQUATION 4-1:**

$$I_{RSFT} = (0.2 V/R_{SFT}) \times 1000$$

Using a  $167\Omega$  RSET resistor will achieve the maximum current limit for the MIC79110 at 1.2 amperes.

#### 4.3 End-of-Charge

The  $R_{EOC}$  pin is connected to a resistor-to-ground. This resistor is used to set the end of charge current for the lithium-ion battery as in Equation 4-2:

#### **EQUATION 4-2:**

$$I_{FOC} = (0.2 V/R_{FOC}) \times 1000$$

Using a 4 k $\Omega$   $R_{EOC}$  resistor will set the end-of-charge current at 50 mA.

I<sub>EOC</sub> should be set at 10% of the battery's rated current.

#### 4.4 Digital End-of-Charge Output

This pin is the output of an open drain. When tied high to the supply using a resistor, the output will toggle high or low depending on the output current of I<sub>BAT</sub>.

- Low state indicates that the I<sub>BAT</sub> current is higher than the programmed current set by R<sub>EOC</sub>.
- High state indicates that the I<sub>BAT</sub> current is lower than the programmed current set by R<sub>EOC</sub>. The output goes high impedance indicating end-of-charge.

#### 4.5 Analog End-of-Charge Output

The ACHG pin provides a small current that is proportional to the charge current. The ratio is set at 1/1000th of the output current.

#### 4.6 Shutdown

The SD pin serves as a logic input (active low) to enable the charger.

Built-in hysteresis for the shutdown pin is 50 mV over temperature.

#### 4.7 Reverse Polarity Protection

In the event that  $V_{BAT} > V_{IN}$  and the shutdown pin is active low, there is reverse battery current protection built in. The current is limited to less than 10  $\mu$ A over temperature.

#### 4.8 Constant Output Voltage/Current Charging

The MIC79110 features constant voltage and constant current output to correctly charge lithium-ion batteries. The constant voltage is either 4.2V or adjustable. The constant current is set by the  $R_{SET}$  pin and is constant down to around 300 mV. Because  $R_{SET}$  can be set below 500 mA, the minimum output current is set at 500 mA for output voltages below 100 mV. This minimum voltage starts the charging process in lithium-ion batteries. If the output current is too low, the battery will not begin charge.

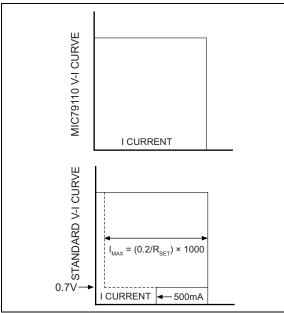
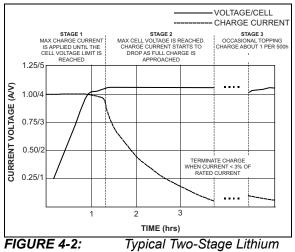


FIGURE 4-1: MIC79110 Constant Output Voltage.

#### 4.9 Lithium-ion Batteries

Lithium-ion batteries are charged in two stages to reach full capacity. The first stage charges the battery with maximum charge current until 90% of the battery cell's voltage limit is reached. The second stage tops off the charge with constant voltage charge as the charge current slowly decreases. End of charge is reached when the current is less than 3% of the rated current. A third stage will occasionally top off with charge with constant voltage charge if the battery voltage drops below a certain threshold.



Charge Profile.

All lithium-ion batteries take approximately 3 hours to charge with the second stage taking twice as long as the first stage. Some chargers claim to be fast chargers by skipping the second stage and just charges the battery until the cell voltage is reached. This only charges the battery to 70% capacity.

An increase in the charge current during Stage 1 does not shorten the total charge time. It will only shorten the time for Stage 1 to complete and lengthen the time in Stage 2.

The lithium-ion loses charge due to aging whether it is used or not. Do not store the batteries at full charge and high heat because it will accelerate the aging process. Try and store with 40% charge and in a cool environment.

#### 4.10 Lithium-ion Safety Precautions

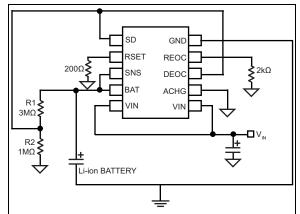
Every lithium-ion battery pack should have a safety circuit which monitors the charge and discharge of the pack and prevents dangerous occurrences.

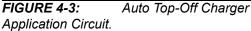
The specifications of these safety circuits are dictated by the cell manufacturer and may include the following:

- · Reverse polarity protection.
- Charge temperature must not be charged when temperature is lower than 0°C or above 45°C.
- Charge current must not be too high, typically below 0.7°C.
- Discharge current protection to prevent damage due to short circuits.
- Protection circuitry for over voltage applied to the battery terminals.
- Overcharge protection circuitry to stop charge when the voltage per cell rises above 4.3V.
- Over discharge protection circuitry to stop discharge when the battery voltage falls below 2.3V (varies with manufacturer).
- Thermal shutdown protection for the battery if the ambient temperature is above 100°C.

#### 4.11 Auto Top-Off Charger Application Circuit

Lithium-ion batteries will begin to lose their charge over time. The MIC79110 can be configured to automatically recharge the battery when the voltage drops below the minimum battery voltage. This minimum voltage is set by a resistor divider at the battery and is connected to the SD pin. For instance, if V<sub>BAT</sub> is 4.2V and the battery voltage falls to 3.72V, SD pin gets divided down by R1 and R2 to 0.93V and starts the normal charging process. While charging, the DEOC indicator is turned on, pulling the SD pin to GND, keeping the MIC79110 on. When the end of charge is reached, the DEOC pin opens. The divided down BAT voltage is now 1.05V at the SD pin, ending the charging process.





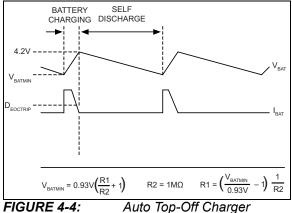
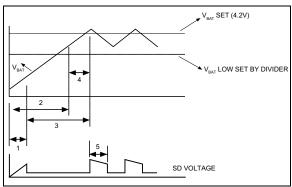


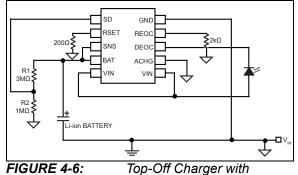
FIGURE 4-4: Auto T Application.





Charging Description.

- SD not held low by active high DEOC because DEOC comparator's inputs do not common-mode to ground. Divider holds SD low so part can start.
- 2. SD held low by divider.
- 3. SD held low by active high DEOC.
- 4. Divider voltage above SD threshold and DEOC open.
- 5. Divider voltage drops below SD threshold and charging begins again.



Internal Reset Application Circuit.

This circuit is similar to the auto top-off charger circuit mentioned above except that the DEOC pin is externally triggered to restart the charging cycle. It still uses the same resistor divider to set the minimum battery voltage before the lithium-ion needs to be recharged.

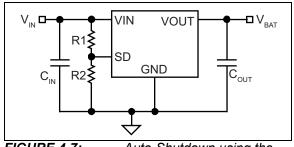


FIGURE 4-7: Auto-Shutdown using the Shutdown Pin.

The shutdown pin on the MIC79110 can be used to automatically shutdown the battery charger when the input voltage rises above a safe operating voltage. To keep the part from heating up and entering thermal shutdown, we can connect the shutdown pin to VIN using a resistor divider. Use Equation 4-3 to setup the maximum  $V_{IN}$ :

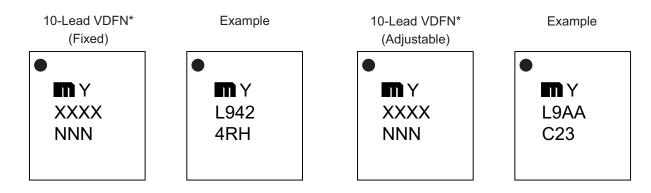
#### **EQUATION 4-3:**

$$\frac{V_{IN(MAX)}}{V_{SD}} = \frac{R1}{R2} + 1$$

The MIC79110 can be connected to a wall wart with a rectified DC voltage and protected from over voltages at the input.

#### 5.0 PACKAGING INFORMATION

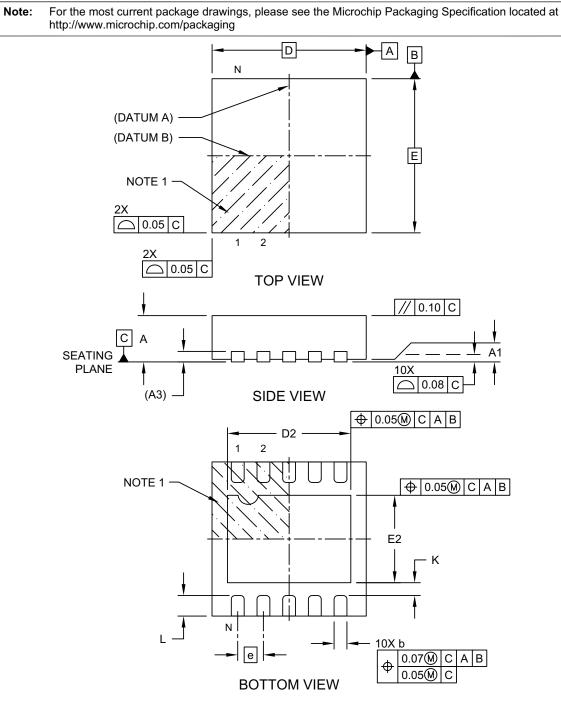
#### 5.1 Package Marking Information



Legend:	XXX Y YY WW NNN (€3 * •, ▲, ▼ mark).	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (€3) can be found on the outer packaging for this package.
k c	be carried characters he corpor	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available of or customer-specific information. Package may or may not include ate logo. (_) symbol may not be to scale.

Note: If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space:
 6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN;
 2 Characters = NN; 1 Character = N

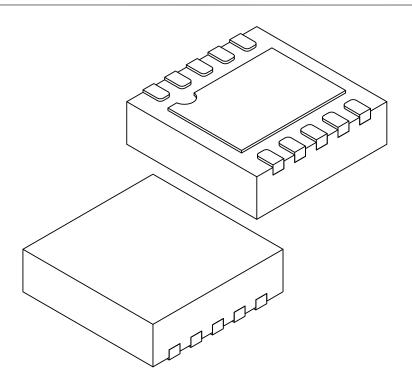
#### 10-Lead Very Thin Plastic Dual Flat, No Lead Package (JFA) - 3x3x0.9 mm Body [VDFN] Micrel Legacy Package DFN33-10LD-PL-1



Microchip Technology Drawing C04-1019-JFA Rev A Sheet 1 of 2

#### 10-Lead Very Thin Plastic Dual Flat, No Lead Package (JFA) - 3x3x0.9 mm Body [VDFN] Micrel Legacy Package DFN33-10LD-PL-1

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX			
Number of Terminals	Ν		10				
Pitch	е		0.50 BSC				
Overall Height	Α	0.80	0.85	0.90			
Standoff	A1	0.00	0.02	0.05			
Terminal Thickness	A3	0.203 REF					
Overall Length	D		3.00 BSC				
Exposed Pad Length	D2	2.35 2.40 2.45					
Overall Width	E		3.00 BSC				
Exposed Pad Width	E2	1.65	1.70	1.75			
Terminal Width	b	0.20 0.25 0.30					
Terminal Length	L	0.35 0.40 0.45					
Terminal-to-Exposed-Pad	K	0.20	-	-			

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

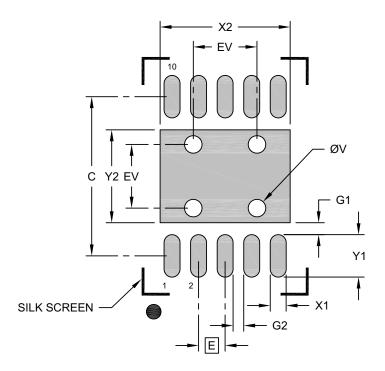
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1019-JFA Rev A Sheet 2 of 2

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#### RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	Dimension Limits			
Contact Pitch	E		0.50 BSC	
Optional Center Pad Width	X2			2.45
Optional Center Pad Length	Y2			1.75
Contact Pad Spacing	С		3.00	
Contact Pad Width (Xnn)	X1			0.30
Contact Pad Length (Xnn)	Y1			0.80
Contact Pad to Center Pad (Xnn)	G1	0.23		
Contact Pad to Contact Pad (Xnn)	G2	0.20		
Thermal Via Diameter	V		0.33	
Thermal Via Pitch	EV		1.20	

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-3019-JFA Rev A

NOTES:

#### APPENDIX A: REVISION HISTORY

#### Revision A (August 2022)

- Converted Micrel document MIC79110 to Microchip data sheet DS20006715A.
- Minor text changes throughout.

NOTES:

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To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Part Number	[- <u>X.X]</u>	<u>x</u>	<u>xx</u>	- <u>XX</u>	Example	s:	
Device O	utput Voltage	Temp. Range	Package	Media Type	a) MIC79	110YML-TR:	MIC79110, Adjustable Output Voltage, -40°C to +125°C Temp. Range, 10-Lead VDFN, 5,000/Reel
Device:	MIC79110:	Simple 1.2	A Linear Li-ion Ba	attery Charger	b) MIC79	110-4.2YML-TR:	MIC79110, 4.2V Output Volt- age, -40°C to +125°C Temp.
Output Voltage:	<blank> = 4.2 = 4.</blank>	Adjustable 2V					Range, 10-Lead VDFN, 5,000/Reel
Temperature Range:	Y =	40°C to +125°C			catalog part nun used for orderin		dentifier only appears in the ber description. This identifier is g purposes and is not printed on age. Check with your Microchip
Package:	ML = 1	0-Lead 3 mm x	3 mm VDFN				package availability with the Tape
Media Type:	TR = 5	,000/Reel					

NOTES:

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